

General Description

The MAX9205/MAX9207 serializers transform 10-bitwide parallel LVCMOS/LVTTL data into a serial highspeed bus low-voltage differential signaling (LVDS) data stream. The serializers typically pair with deserializers like the MAX9206/MAX9208, which receive the serial output and transform it back to 10-bit-wide parallel data.

The MAX9205/MAX9207 transmit serial data at speeds up to 400Mbps and 660Mbps, respectively, over PCB traces or twisted-pair cables. Since the clock is recovered from the serial data stream, clock-to-data and data-to-data skew that would be present with a parallel bus are eliminated.

The serializers require no external components and few control signals. The input data strobe edge is selected by TCLK_R/F. PWRDN is used to save power when the devices are not in use. Upon power-up, a synchronization mode is activated, which is controlled by two SYNC inputs, SYNC1 and SYNC2.

The MAX9205 can lock to a 16MHz to 40MHz system clock, while the MAX9207 can lock to a 40MHz to 66MHz system clock. The serializer output is held in high impedance until the device is fully locked to the local system clock, or when the device is in powerdown mode.

Both the devices operate from a single +3.3V supply. are specified for operation from -40°C to +85°C, and are available in 28-pin SSOP packages.

Applications

Cellular Phone Base Stations

Add Drop Muxes

Digital Cross-Connects

DSLAMs

Network Switches and

Routers

Backplane Interconnect

Features

- ♦ Standalone Serializer (vs. SERDES) Ideal for **Unidirectional Links**
- **♦** Framing Bits for Deserializer Resync Allow Hot **Insertion Without System Interruption**
- ♦ LVDS Serial Output Rated for Point-to-Point and **Bus Applications**
- ♦ Wide Reference Clock Input Range 16MHz to 40MHz (MAX9205) 40MHz to 66MHz (MAX9207)
- ♦ Low 140ps (pk-pk) Deterministic Jitter (MAX9207)
- **♦ Low 34mA Supply Current (MAX9205)**
- **♦ 10-Bit Parallel LVCMOS/LVTTL Interface**
- ♦ Up to 660Mbps Payload Data Rate (MAX9207)
- ♦ Programmable Active Edge on Input Latch
- ♦ Pin-Compatible Upgrades to DS92LV1021 and DS92LV1023

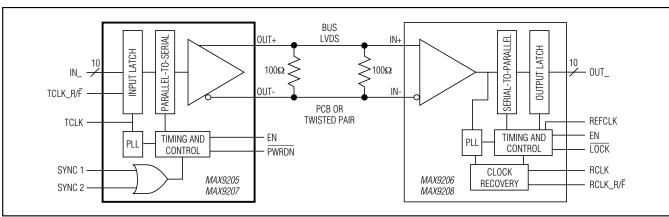
Ordering Information

PART	TEMP RANGE	PIN- PACKAGE	REF CLOCK RANGE (MHz)	
MAX9205EAI+	-40°C to +85°C	28 SSOP	16 to 40	
MAX9205EAI/V+	-40°C to +85°C	28 SSOP	16 to 40	
MAX9207EAI+	-40°C to +85°C	28 SSOP	40 to 66	

⁺Denotes a lead(Pb)-free/RoHS-compliant package. N denotes an automotive qualified part.

Pin Configuration and Functional Diagram appear at end of data sheet.

Typical Application Circuit



ABSOLUTE MAXIMUM RATINGS

AVCC, DVCC to GND0.3V to +4.0V	Storage Temperature Range65°C to +150°C
IN_, SYNC1, SYNC2, EN, TCLK_R/F, TCLK,	Junction Temperature+150°C
PWRDN to GND0.3V to (V _{CC} + 0.3V)	Operating Temperature Range40°C to +85°C
OUT+, OUT- to GND0.3V to +4.0V	ESD Protection (Human Body Model, OUT+, OUT-)±8kV
Output Short-Circuit DurationContinuous	Lead Temperature (soldering, 10s)+300°C
Continuous Power Dissipation (T _A = +70°C)	Soldering Temperature (reflow)+260°C
28-Pin SSOP (derate 9.5mW/°C above +70°C)762mW	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

PACKAGE THERMAL CHARACTERISTICS (Note 1)

SSOP

Note 1: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

DC ELECTRICAL CHARACTERISTICS

 $(V_{AVCC} = V_{DVCC} = +3.0V \text{ to } +3.6V, R_L = 27\Omega \pm 1\% \text{ or } 50\Omega \pm 1\%, C_L = 10 \text{pF}, T_A = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}.$ Typical values are at $V_{AVCC} = V_{DVCC} = +3.3V$ and $T_A = +25^{\circ}\text{C}$, unless otherwise noted.) (Notes 2, 3, 4)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
LVCMOS/LVTLL LOGIC INPUTS	(INO TO INS	, EN, SYNC1, SYNC	2, TCLK, TCL	.K_R/F, PWRI	DN)			
High-Level Input Voltage	V _{IH}				2.0		Vcc	V
Low-Level Input Voltage	V _{IL}				GND		0.8	V
Input Current	I _{IN}	V _{IN} _ = 0V or V_VCC			-20		+20	μΑ
BUS LVDS OUTPUTS (OUT+, OL	JT-)							
Differential Output Voltage	Vop	Figure 1	$R_L = 27\Omega$		200	286	400	mV
Differential Output Voltage	VOD	rigule i	$R_L = 50\Omega$		250	460	600	mV
Change in V _{OD} Between Complementary Output States	ΔV _{OD}	Figure 1	Figure 1			1	35	mV
Output Offset Voltage	Vos	Figure 1			0.9	1.15	1.3	V
Change in V _{OS} Between Complementary Output States	ΔVos	Figure 1				3	35	mV
Output Short-Circuit Current	los	V_{OUT+} or $V_{OUT-} = 0V$, $IN0$ to $IN9 = \overline{PWRDN} = EN = high$			-13	-15	mA	
Output High-Impedance Current	loz	V _{PWRDN} or V _{EN} = 0.8V, V _{OUT+} or V _{OUT-} = 0V or V v _{CC}		-10		+10	μΑ	
Power-Off Output Current	IOX	V_VCC = 0V, VOUT+	or V _{OUT} - = 0	V or 3.6V	-10		+10	μΑ
POWER SUPPLY								
			MANOOOF	16MHz		23	35	
Supply Current	Icc	R _L = 27_ or 50_ worst-case pattern (Figures 2, 4)	MAX9205	40MHz		34	45	mA
			MAX9207 40N	40MHz		32	50	
				66MHz		45	60	
Power-Down Supply Current	Iccx	PWRDN = low				8	mA	

AC ELECTRICAL CHARACTERISTICS

 $(V_{AVCC} = V_{DVCC} = +3.0V \text{ to } +3.6V, \ R_L = 27\Omega \pm 1\% \text{ or } 50\Omega \pm 1\%, \ C_L = 10 \text{pF}, \ T_A = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}. \ \text{Typical values are at } V_{AVCC} = V_{DVCC} = +3.3V \text{ and } T_A = +25^{\circ}\text{C}, \ \text{unless otherwise noted.}) \ (\text{Notes } 3, 5)$

PARAMETER	SYMBOL	С	ONDITIONS	MIN	TYP	MAX	UNITS
TRANSMIT CLOCK (TCLK) TIM	ING REQUIRE	MENTS					
TOLK Contor Francisco	6		MAX9205	16		40	MHz
TCLK Center Frequency	fTCCF		MAX9207	40		66	MHz
TCLK Frequency Variation	TCFV		·	-200		200	ppm
TCLK Period	trop		MAX9205	25		62.5	no
TOLK FEIIOU	tTCP		MAX9207	15.15		25	ns
TCLK Duty Cycle	TCDC			40		60	%
TCLK Input Transition Time	tclkt	Figure 3			3	6	ns
TCLK Input Jitter	tJI⊤					150	ps (RMS)
SWITCHING CHARACTERISTIC	cs			'			
Low-to-High Transition Time	t _{LHT}	Figure 4	$R_L = 27\Omega$	150	300	400	ps
Low-to-riigh fransition filme	'LHI	rigure 4	$R_L = 50\Omega$	150	350	500	
High-to-Low Transition Time	tHLT	Figure 4	$R_L = 27\Omega$	150	300	400	- ps
riigii to Low Transition Time			$R_L = 50\Omega$	150	350	500	
IN_ Setup to TCLK	ts	Figure 5		1			ns
IN_ Hold from TCLK	tH	Figure 5		3			ns
OUTPUT High State to High- Impedance Delay	tHZ	Figures 6, 7			4.5	10	ns
OUTPUT Low State to High- Impedance Delay	tLZ	Figures 6, 7			4.5	10	ns
OUTPUT High Impedance to High-State Delay	tzH	Figures 6, 7			4.5	10	ns
OUTPUT High Impedance to Low-State Delay	t _{ZL}	Figures 6, 7			4.5	10	ns
SYNC Pulse Width	t _{SPW}			6 x t _{TCP}			ns
PLL Lock Time	tpL	Figure 7		2048 x t _{TCP}		2049 x t _{TCP}	ns
Bus LVDS Bit Width	t _{BIT}				t _{TCP} /12		ns
Serializer Delay	t _{SD}	Figure 8		t _{TCP} /6		(t _{TCP} /6) + 5	ns

AC ELECTRICAL CHARACTERISTICS (continued)

 $(V_{AVCC} = V_{DVCC} = +3.0 \text{V to } +3.6 \text{V}, R_L = 27\Omega \pm 1\% \text{ or } 50\Omega \pm 1\%, C_L = 10 \text{pF}, T_A = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}.$ Typical values are at $V_{AVCC} = V_{DVCC} = +3.3 \text{V}$ and $T_A = +25 ^{\circ}\text{C}$, unless otherwise noted.) (Notes 3, 5)

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
		MAX9205	16MHz			200	ps (pk-pk)
Deterministic litter (Figure 0)	tDJIT		40MHz			140	
Deterministic Jitter (Figure 9)		MAX9207	40MHz			140	
			66MHz			140	
	trjit	MAX9205	16MHz			13	ps (RMS)
Dandom Litter (Figure 10)			40MHz			9	
Random Jitter (Figure 10)		MAX9207	40MHz			9	
			66MHz			6	

Note 2: Current into a pin is defined as positive. Current out of a pin is defined as negative. All voltages are referenced to ground except V_{OD}, ΔV_{OD}, and V_{OS}.

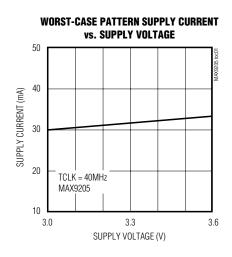
Note 3: CL includes scope probe and test jig capacitance.

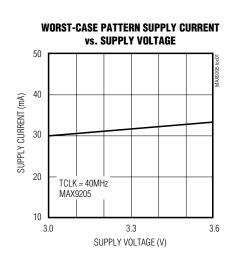
Note 4: Parameters 100% tested at $T_A = +25^{\circ}$ C. Limits over operating temperature range guaranteed by design and characterization.

Note 5: AC parameters are guaranteed by design and characterization.

Typical Operating Characteristics

 $(V_{AVCC} = V_{DVCC} = +3.3V, R_L = 27\Omega, C_L = 10pF, T_A = +25^{\circ}C, unless otherwise noted.)$





Pin Description

PIN	NAME	FUNCTION
1, 2	SYNC 1, SYNC 2	LVCMOS/LVTTL Logic Inputs. The two SYNC pins are ORed. When at least one of the two pins are asserted high for at least six cycles of TCLK, the serializer initiates a transmission of 1024 SYNC patterns. If held high after 1024 SYNC patterns have been transmitted, SYNC patterns continue to be sent until the SYNC pin is asserted low. Toggling a SYNC pin after six TCLK cycles high and before 1024 SYNC patterns have been transmitted does not affect the output of the 1024 SYNC patterns.
3–12	IN0-IN9	LVCMOS/LVTTL Data Inputs. Data is loaded into a 10-bit latch by the selected TCLK edge.
13	TCLK_R/F	LVCMOS/LVTTL Logic Input. High selects a TCLK rising-edge data strobe. Low selects a TCLK falling-edge data strobe.
14	TCLK	LVCMOS/LVTTL Reference Clock Input. The MAX9205 accepts a 16MHz to 40MHz clock. The MAX9207 accepts a 40MHz to 66MHz clock. TCLK provides a frequency reference to the PLL and strobes parallel data into the input latch.
15, 16	DGND	Digital Circuit Ground. Connect to ground plane.
17, 26	AVCC	Analog Circuit Power Supply (Includes PLL). Bypass AVCC to ground with a 0.1µF capacitor and a 0.001µF capacitor. Place the 0.001µF capacitor closest to AVCC.
18, 20, 23, 25	AGND	Analog Circuit Ground. Connect to ground plane.
19	EN	LVCMOS/LVTTL Logic Input. High enables serial data output. Low puts the bus LVDS output into high impedance.
21	OUT-	Inverting Bus LVDS Differential Output
22	OUT+	Noninverting Bus LVDS Differential Output
24	PWRDN	LVCMOS/LVTTL Logic Input. Low puts the device into power-down mode and the output into high impedance.
27, 28	DVCC	Digital Circuit Power Supply. Bypass DVCC to ground with a 0.1μF capacitor and a 0.001μF capacitor. Place the 0.001μF capacitor closest to DVCC.

Detailed Description

The MAX9205/MAX9207 are 10-bit serializers designed to transmit data over balanced media that may be a standard twisted-pair cable or PCB traces at 160Mbps to 660Mbps. The interface may be double-terminated point-to-point or a heavily loaded multipoint bus. The characteristic impedance of the media and connected devices can range from 100Ω for a point-to-point interface to 54Ω for a heavily loaded multipoint bus. A double-terminated point-to-point interface uses a 100Ω -termination resistor at each end of the interface, resulting in a load of 50Ω . A heavily loaded multipoint bus requires a termination as low as 54Ω at each end of the bus, resulting in a termination load of 27Ω . The serializer requires a deserializer such as the MAX9206/MAX9208 for a complete data transmission application.

A high-state start bit and a low-state stop bit, added internally, frame the 10-bit parallel input data and ensure a transition in the serial data stream. Therefore, 12 serial bits are transmitted for each 10-bit parallel input. The MAX9205 accepts a 16MHz to 40MHz reference clock, producing a serial data rate of 192Mbps (12 bits x 16MHz) to 480Mbps (12 bits x 40MHz). The MAX9207 accepts a 40MHz to 66MHz reference clock, producing 480Mbps to 792Mbps. However, since only 10 bits are from input data, the actual throughput is 10 times the TCLK frequency.

To transmit data, the serializers sequence through three modes: initialization mode, synchronization mode, and data transmission mode.

Initialization Mode

When VCC is applied, the outputs are held in high impedance and internal circuitry is disabled by on-chip power-on-reset circuitry. When the supply voltage reaches 2.35V, the PLL starts to lock to a local reference clock (16MHz to 40MHz for MAX9205 and 40MHz to 66MHz for MAX9207). The reference clock, TCLK, is provided by the system. A serializer locks within 2049 cycles of TCLK. Once locked, a serializer is ready to send data or SYNC patterns depending on the levels of SYNC 1 and SYNC 2.

Synchronization Mode

To rapidly synchronize with a deserializer, SYNC patterns can be sent. A SYNC pattern is six consecutive ones followed by six consecutive zeros repeating every TCLK period. When one or both SYNC inputs are asserted high for at least six cycles of TCLK, the serializer will initiate the transmission of 1024 SYNC patterns. The serializer will continue to send SYNC patterns if either of the SYNC input pins remains high. Toggling one SYNC input with the other SYNC input low before 1024 SYNC patterns are output does not interrupt the output of the 1024 SYNC patterns.

Data Transmission Mode

After initialization, both SYNC input pins must be set low by users or through a control signal from the deserializer before data transmission begins. Provided that SYNC inputs are low, input data at IN0–9 are clocked into the serializer by the TCLK input. Setting TCLK_R/F high selects the rising edge of TCLK for data strobe and low selects the falling edge. If either of the SYNC inputs goes high for six TCLK cycles at any time during

data transmission, the data at IN0-9 are ignored and SYNC patterns are sent for at least 1024 TCLK cycles.

A start bit high and a stop bit low frame the 10-bit data and function as the embedded clock edge in the serial data stream. The serial rate is the TCLK frequency times the data and appended bits. For example, if TCLK is 40MHz, the serial rate is $40 \times 12 (10 + 2 \text{ bits}) = 480\text{Mbps}$. Since only 10 bits are from input data, the payload rate is $40 \times 10 = 400\text{Mbps}$.

Power-Down

Power-down mode is entered when the \overline{PWRDN} pin is driven low. In power-down mode, the PLL of the serializer is stopped and the outputs (OUT+ and OUT-) are in high impedance, disabling drive current and also reducing supply current. When \overline{PWRDN} is driven high, the serializer must reinitialize and resynchronize before data can be transferred. On power-up, in order for the MAX9205/MAX9207 to initialize correctly, \overline{PWRDN} should remain below 0.7V until PCLK is stable and all power supplies are within specification.

High-Impedance State

The serializer output pins (OUT+ and OUT-) are held in high impedance when the supply voltage is first applied and while the PLL is locking to the local reference clock. Setting EN or PWRDN low puts the device in high impedance. After initialization, EN functions asynchronously. For example, the serializer output can be put into high impedance while SYNC patterns are being sent without affecting the internal timing of the SYNC pattern generation. However, if the serializer goes into high impedance, a deserializer loses PLL lock and needs to resynchronize before data transfer can resume.

Table 1. Input /Output Function Table

	IN	PUTS		OUTPUTS
EN	PWRDN	SYNC 1	SYNC 2	OUT+, OUT-
Н	Н	When either or both SYNC 1 and SYNC 2 are held high for at least six TCLK cycles		Synchronization Mode. SYNC patterns of six 1s and six 0s are transmitted every TCLK cycle for at least 1024 TCLK cycles. Data at IN0–9 are ignored.
Н	Н	L	L	Data Transmission Mode. IN0–9 and 2 frame bits are transmitted every TCLK cycle.
Х	L	Х	Х	Output in high impadance
L	Х	Х	Х	Output in high-impedance.

X = Don't care.

Applications Information

Power-Supply Bypassing

Bypass AVCC with high-frequency surface-mount ceramic 0.1μF and 0.001μF capacitors in parallel as close to the device as possible, with the smaller valued capacitor closest to AVCC. Bypass DVCC with high-frequency surface-mount ceramic 0.1μF and 0.001μF capacitors in parallel as close to the device as possible, with the smaller valued capacitor closest to DVCC.

Differential Traces and Termination

Output trace characteristics affect the performance of the MAX9205/MAX9207. Use controlled-impedance media and terminate at both ends of the transmission line in the media's characteristic impedance. Termination with a single resistor at the end of a point-to-point link typically provides acceptable performance. However, the MAX9205/MAX9207 output levels are specified for double-terminated point-to-point and multipoint applications. With a single 100Ω termination, the output swing is larger.

Avoid the use of unbalanced cables such as ribbon or simple coaxial cable. Balanced cables such as twisted pair offer superior signal quality and tend to generate less EMI due to canceling effects. Balanced cables tend to pick up noise as common mode, which is rejected by a differential receiver.

Eliminate reflections and ensure that noise couples as common mode by running the differential traces close together. Reduce skew by matching the electrical length of the traces. Excessive skew can result in a degradation of magnetic field cancellation.

The differential output signals should be routed close to each other to cancel their external magnetic field. Maintain a constant distance between the differential traces to avoid discontinuities in differential impedance. Avoid 90° turns and minimize the number of vias to further prevent impedance discontinuities.

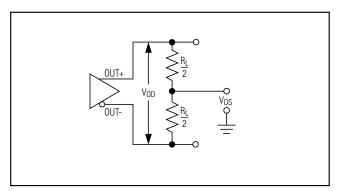


Figure 1. Output Voltage Definitions

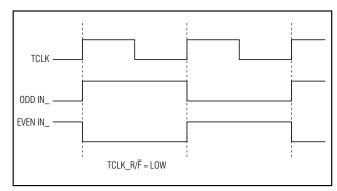


Figure 2. Worst-Case I_{CC} Test Pattern

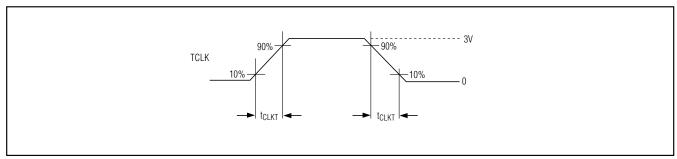


Figure 3. Input Clock Transition Time Requirement

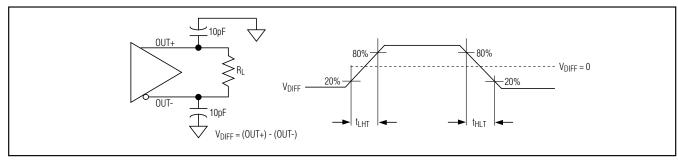


Figure 4. Output Load and Transition Times

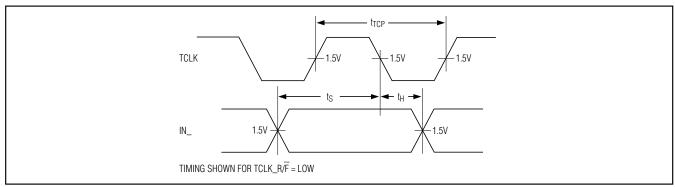


Figure 5. Data Input Setup and Hold Times

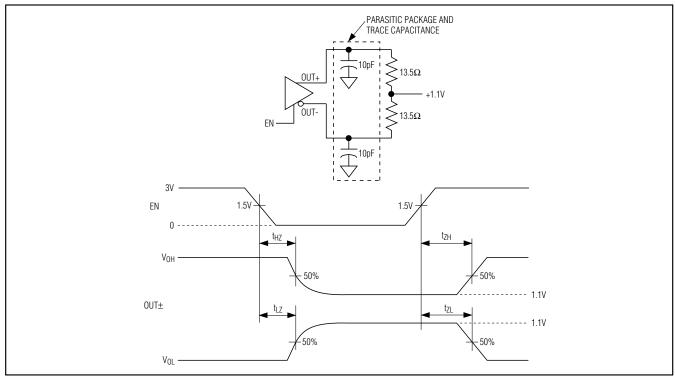


Figure 6. High-Impedance Test Circuit and Timing

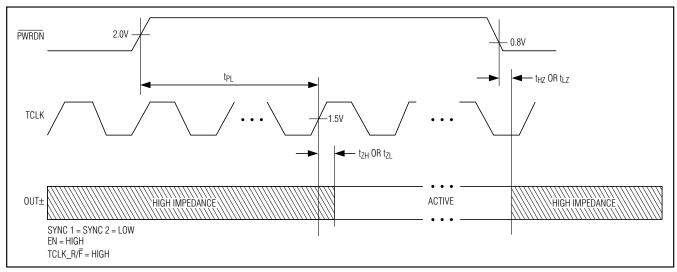


Figure 7. PLL Lock Time and PWRDN High-Impedance Delays

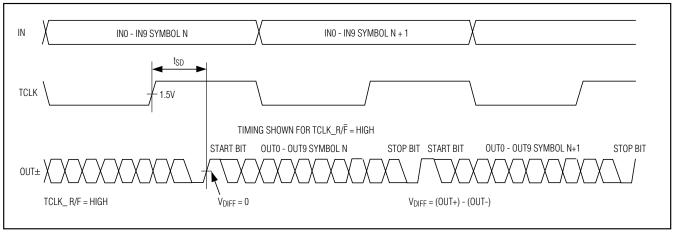


Figure 8. Serializer Delay

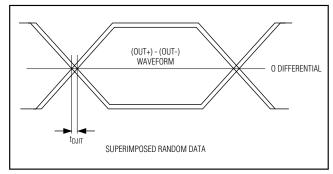


Figure 9. Definition of Deterministic Jitter (t_{DJIT})

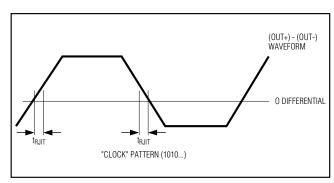


Figure 10. Definition of Random Jitter (t_{RJIT})

Topologies

The serializers can operate in a variety of topologies. Examples of double-terminated point-to-point, multidrop, point-to-point broadcast, and multipoint topologies are shown in Figures 11 through 14. Use 1% surface-mount termination resistors.

A point-to-point connection terminated at each end in the characteristic impedance of the cable or PCB traces is shown in Figure 11. The total load seen by the serializer is 50Ω . The double termination typically

reduces reflections compared to a single 100 Ω termination. A single 100 Ω termination at the deserializer input is feasible and will make the differential signal swing larger.

A serializer located at one end of a backplane bus driving multiple deserializers in a multidrop configuration is shown in Figure 12. A 54Ω resistor at the far end terminates the bus. This topology allows "broadcast" of data with a minimum of interconnect.

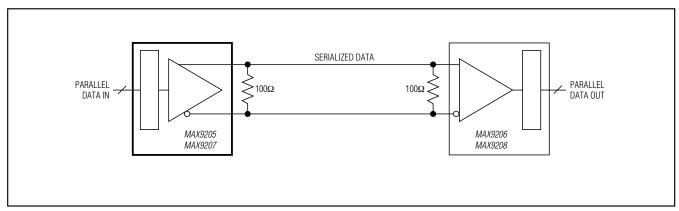


Figure 11. Double-Terminated Point-to-Point

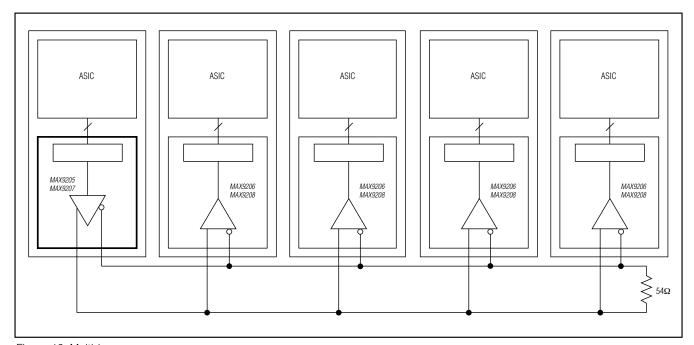


Figure 12. Multidrop

A point-to-point version of the multidrop bus is shown in Figure 13. The low-jitter MAX9150 10-port repeater is used to reproduce and transmit the serializer output over 10 double-terminated point-to-point links. Compared to the multidrop bus, more interconnect is traded for more robust hot-plug capability.

The repeater eliminates nine serializers compared to 10 individual point-to-point serializer-to-deserializer connections. Since repeater jitter subtracts from the serializer-deserializer timing margin, a low-jitter repeater is essential in most high data rate applications.

Multiple serializers and deserializers bused over a differential serial connection on a backplane are shown in Figure 14. The second serializer can be a backup to the primary serializer. The typical close spacing (1in or less) of cards on a backplane reduces the characteristic impedance by as much as half the initial, unloaded value. Termination resistors that match the loaded characteristic impedance are required at each end of the bus. The total loaded seen by the serializer is 27Ω in this case.

Board Layout

For bus LVDS applications, a four-layer PCB that provides separate power, ground, and input/output signals is recommended. Separate LVTTL/LVCMOS and bus LVDS signals from each other to prevent coupling into the bus LVDS lines.

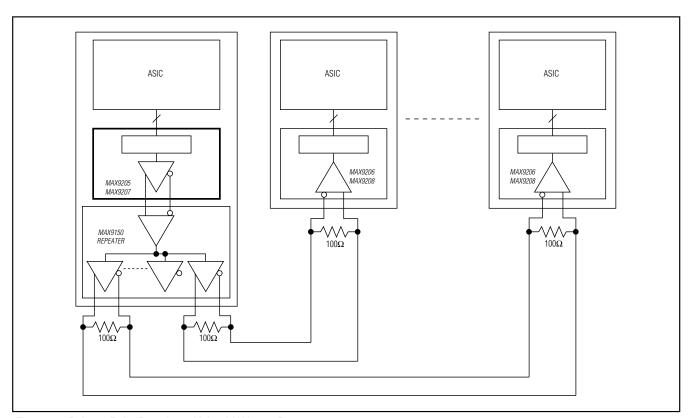


Figure 13. Point-to-Point Broadcast Using MAX9150 Repeater

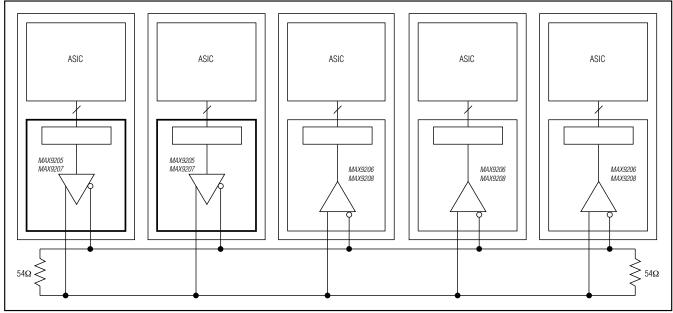
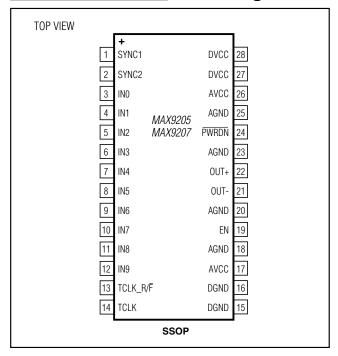


Figure 14. Multipoint

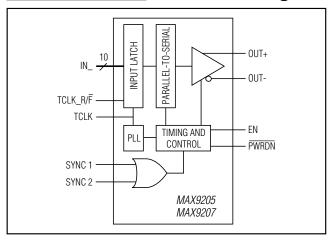
Pin Configuration



Chip Information

PROCESS: CMOS

Functional Diagram



Package Information

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/package. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
28 SSOP	A28+4	<u>21-0056</u>	<u>90-0095</u>

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	5/01	Initial release	_
1	11/10	Updated Ordering Information, Absolute Maximum Ratings, and Package	1, 2, 13
2	10/12	Added Package Thermal Characteristics section and updated the Electrical Characteristics and the Power-Down sections	2–4, 6



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